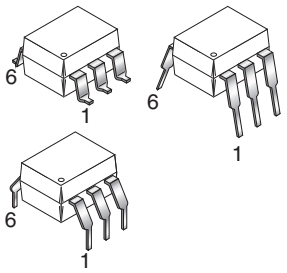
FAIRCHILD
SEMICONDUCTOR®

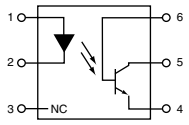
GENERAL PURPOSE 6-PIN PHOTOTRANSISTOR OPTOCOUPLERS

4N25	**4N26**	**4N27**	**4N28**	**4N35**	**4N36**
4N37	**H11A1**	**H11A2**	**H11A3**	**H11A4**	**H11A5**

WHITE PACKAGE (-M SUFFIX)

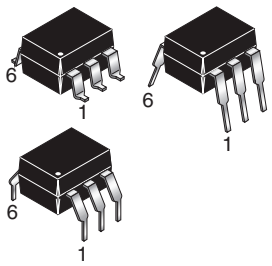


SCHEMATIC



PIN 1. ANODE
2. CATHODE
3. NO CONNECTION
4. EMITTER
5. COLLECTOR
6. BASE

BLACK PACKAGE (NO -M SUFFIX)



DESCRIPTION

The general purpose optocouplers consist of a gallium arsenide infrared emitting diode driving a silicon phototransistor in a 6-pin dual in-line package.

FEATURES

- Also available in white package by specifying -M suffix, eg. 4N25-M
- UL recognized (File # E90700)
- VDE recognized (File # 94766)
  - Add option V for white package (e.g., 4N25V-M)
  - Add option 300 for black package (e.g., 4N25.300)

APPLICATIONS

- Power supply regulators
- Digital logic inputs
- Microprocessor inputs

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ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise specified)

Parameter	Symbol	Value	Units
TOTAL DEVICE			
Storage Temperature	T_{STG}	-55 to +150	°C
Operating Temperature	T_{OPR}	-55 to +100	°C
Wave solder temperature (see page 14 for reflow solder profiles)	T_{SOL}	260 for 10 sec	°C
Total Device Power Dissipation @ T_A = 25°C	P_D	250	mW
Derate above 25°C		3.3 (non-M), 2.94 (-M)	
EMITTER			
DC/Average Forward Input Current	I_F	100 (non-M), 60 (-M)	mA
Reverse Input Voltage	V_R	6	V
Forward Current - Peak (300µs, 2% Duty Cycle)	I_F(pk)	3	A
LED Power Dissipation @ T_A = 25°C	P_D	150 (non-M), 120 (-M)	mW
Derate above 25°C		2.0 (non-M), 1.41 (-M)	mW/°C
DETECTOR			
Collector-Emitter Voltage	V_{CEO}	30	V
Collector-Base Voltage	V_{CBO}	70	V
Emitter-Collector Voltage	V_{ECO}	7	V
Detector Power Dissipation @ T_A = 25°C	P_D	150	mW
Derate above 25°C		2.0 (non-M), 1.76 (-M)	mW/°C

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ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise specified)

INDIVIDUAL COMPONENT CHARACTERISTICS

Parameter	Test Conditions	Symbol	Min	Typ*	Max	Unit
EMITTER						
Input Forward Voltage	(I_F = 10 mA)	V_F		1.18	1.50	V
Reverse Leakage Current	(V_R = 6.0 V)	I_R		0.001	10	µA
DETECTOR						
Collector-Emitter Breakdown Voltage	(I_C = 1.0 mA, I_F = 0)	BV_{CEO}	30	100		V
Collector-Base Breakdown Voltage	(I_C = 100 µA, I_F = 0)	BV_{CBO}	70	120		V
Emitter-Collector Breakdown Voltage	(I_E = 100 µA, I_F = 0)	BV_{ECO}	7	10		V
Collector-Emitter Dark Current	(V_{CE} = 10 V, I_F = 0)	I_{CEO}		1	50	nA
Collector-Base Dark Current	(V_{CB} = 10 V)	I_{CBO}			20	nA
Capacitance	(V_{CE} = 0 V, f = 1 MHz)	C_{CE}		8		pF

ISOLATION CHARACTERISTICS

Characteristic	Test Conditions	Symbol	Min	Typ*	Max	Units
Input-Output Isolation Voltage	(Non '-M', Black Package) (f = 60 Hz, t = 1 min)	V_{ISO}	5300			Vac(rms)
	('-M', White Package) (f = 60 Hz, t = 1 sec)		7500			Vac(pk)
Isolation Resistance	(V_{I-O} = 500 VDC)	R_{ISO}	10^{11}			Ω
Isolation Capacitance	(V_{I-O} = &, f = 1 MHz)	C_{ISO}		0.5		pF
	('-M' White Package)			0.2	2	pF

Note
* Typical values at T_A = 25°C

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TRANSFER CHARACTERISTICS (T_A = 25°C Unless otherwise specified.)

DC Characteristic	Test Conditions	Symbol	Device	Min	Typ*	Max	Unit
Current Transfer Ratio, Collector to Emitter	(I_F = 10 mA, V_{CE} = 10 V)	CTR	4N35 4N36 4N37	100			%
			H11A1	50			
			H11A5	30			
			4N25 4N26 H11A2 H11A3	20			
			4N27 4N28 H11A4	10			
	(I_F = 10 mA, V_{CE} = 10 V, T_A = -55°C)		4N35 4N36 4N37	40			
	(I_F = 10 mA, V_{CE} = 10 V, T_A = +100°C)		4N35 4N36 4N37	40			
Collector-Emitter Saturation Voltage	(I_C = 2 mA, I_F = 50 mA)	$V_{CE\ (SAT)}$	4N25 4N26 4N27 4N28			0.5	V
	(I_C = 0.5 mA, I_F = 10 mA)		4N35 4N36 4N37			0.3	
			H11A1 H11A2 H11A3 H11A4 H11A5			0.4	
AC Characteristic Non-Saturated Turn-on Time	(I_F = 10 mA, V_{CC} = 10 V, R_L = 100Ω) (Fig.20)	T_{ON}	4N25 4N26 4N27 4N28 H11A1 H11A2 H11A3 H11A4 H11A5		2		µs
Non Saturated Turn-on Time	(I_C = 2 mA, V_{CC} = 10 V, R_L = 100Ω) (Fig.20)	T_{ON}	4N35 4N36 4N37		2	10	µs

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TRANSFER CHARACTERISTICS (T_A = 25°C Unless otherwise specified.) (Continued)

AC Characteristic	Test Conditions	Symbol	Device	Min	Typ*	Max	Unit
Turn-off Time	(I_F = 10 mA, V_{CC} = 10 V, R_L = 100Ω) (Fig.20)	T_{OFF}	4N25 4N26 4N27 4N28 H11A1 H11A2 H11A3 H11A4 H11A5		2		µs
	(I_C = 2 mA, V_{CC} = 10 V, R_L = 100Ω) (Fig.20)		4N35 4N36 4N37		2	10	

* Typical values at T_A = 25°C

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TYPICAL PERFORMANCE CURVES

Fig. 1 LED Forward Voltage vs. Forward Current (Black Package)

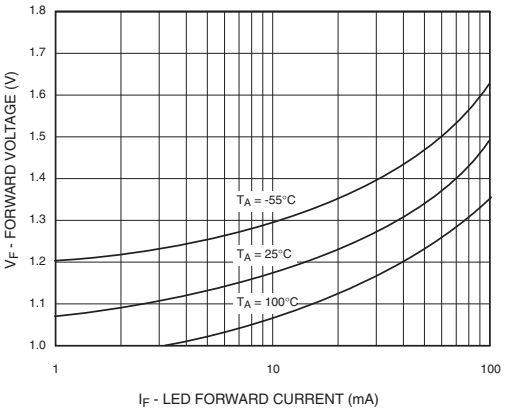


Fig. 2 LED Forward Voltage vs. Forward Current (White Package)

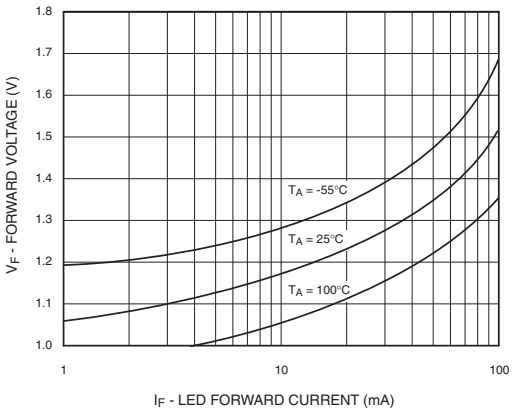


Fig.3 Normalized CTR vs. Forward Current (Black Package)

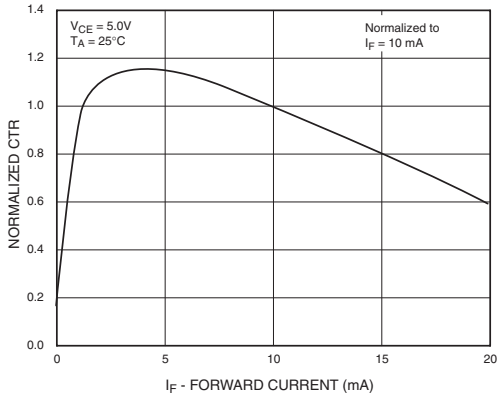


Fig.4 Normalized CTR vs. Forward Current (White Package)

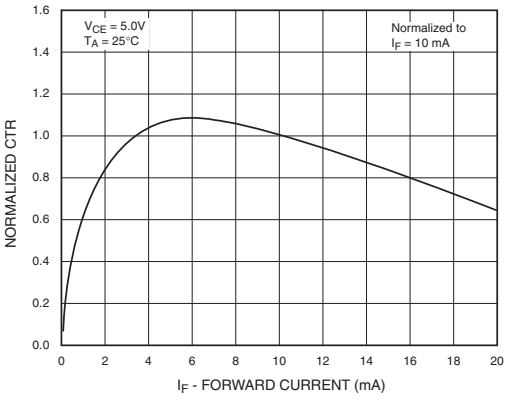


Fig. 5 Normalized CTR vs. Ambient Temperature (Black Package)

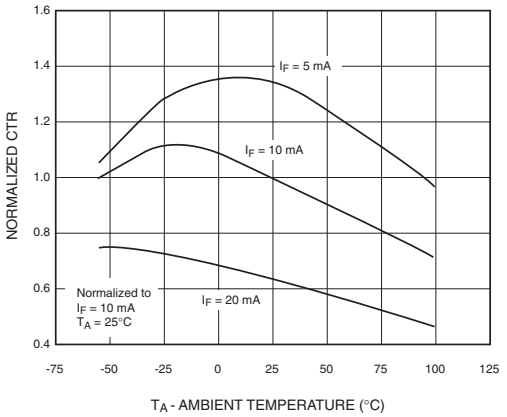
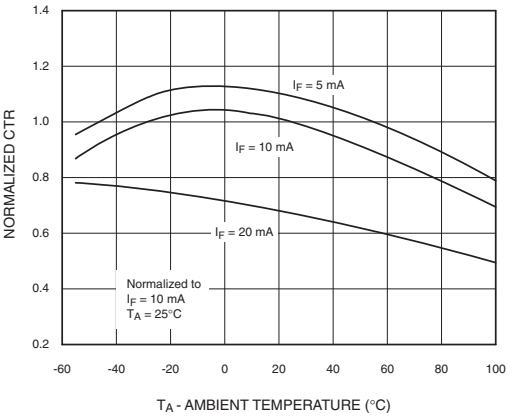


Fig. 6 Normalized CTR vs. Ambient Temperature (White Package)



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Fig. 7 CTR vs. RBE (Unsaturated) (Black Package)

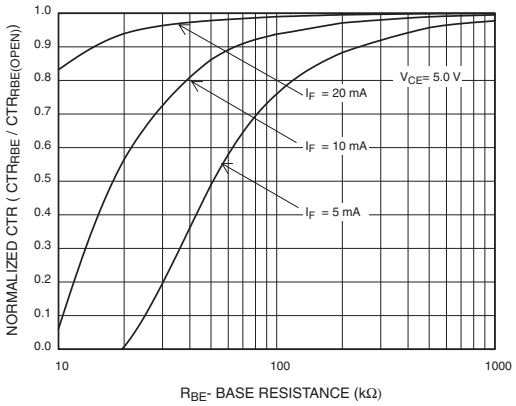


Fig. 8 CTR vs. RBE (Unsaturated) (White Package)

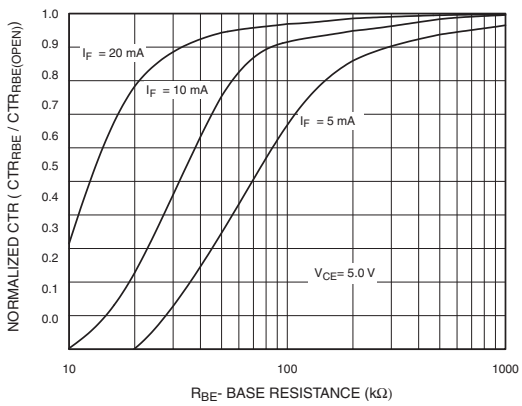


Fig. 9 CTR vs. RBE (Saturated) (Black Package)

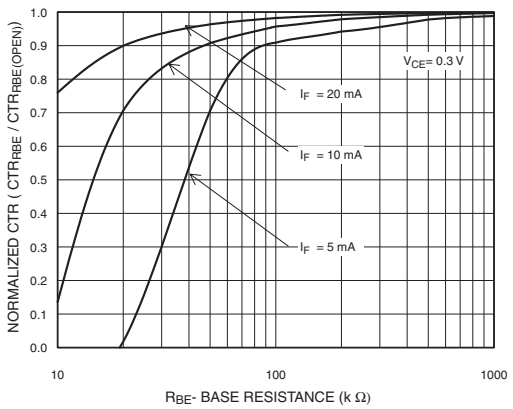


Fig. 10 CTR vs. RBE (Saturated) (White Package)

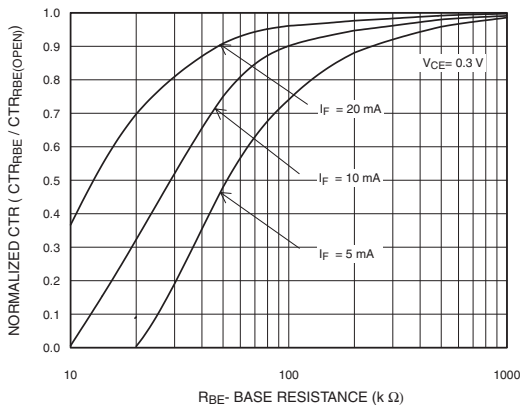


Fig. 11 Collector-Emitter Saturation Voltage vs Collector Current (Black Package)

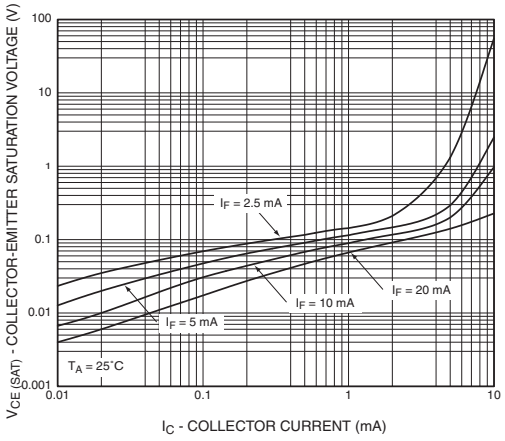
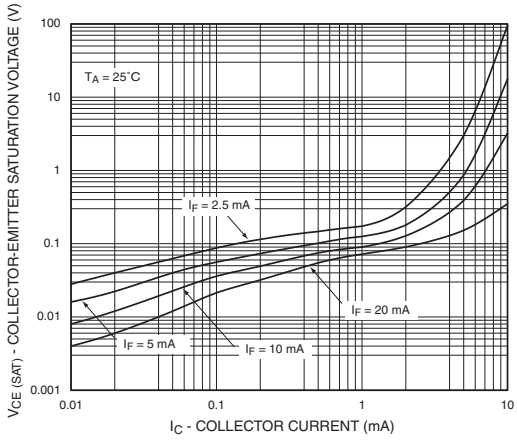


Fig. 12 Collector-Emitter Saturation Voltage vs Collector Current (White Package)



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Fig. 13 Switching Speed vs. Load Resistor (Black Package)

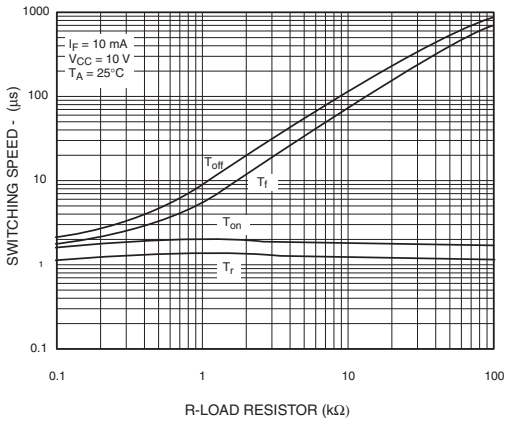


Fig. 14 Switching Speed vs. Load Resistor (White Package)

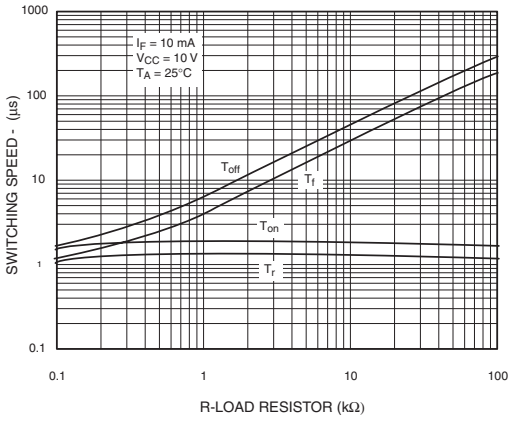


Fig. 15 Normalized t_{on} vs. R_{BE} (Black Package)

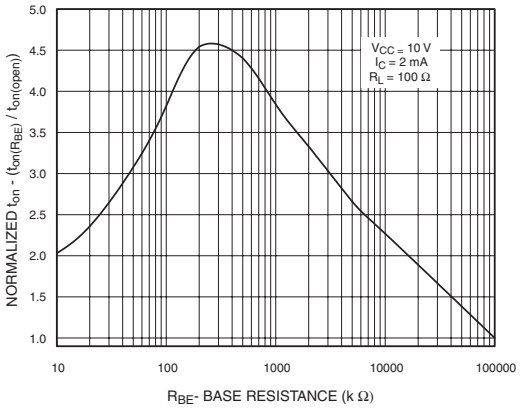


Fig. 16 Normalized t_{on} vs. R_{BE} (White Package)

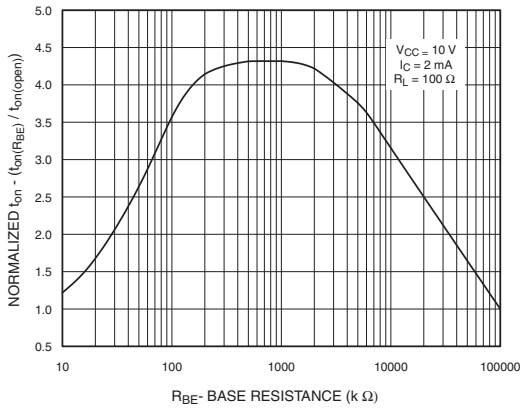


Fig. 17 Normalized t_{off} vs. R_{BE} (Black Package)

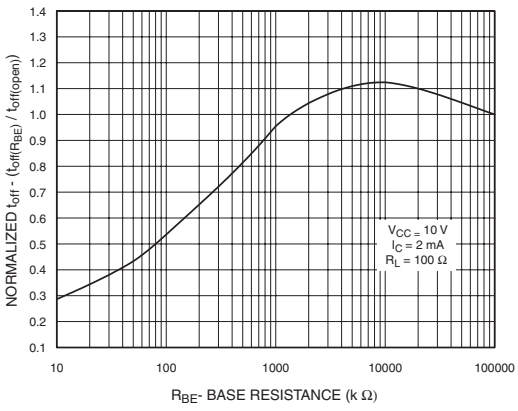
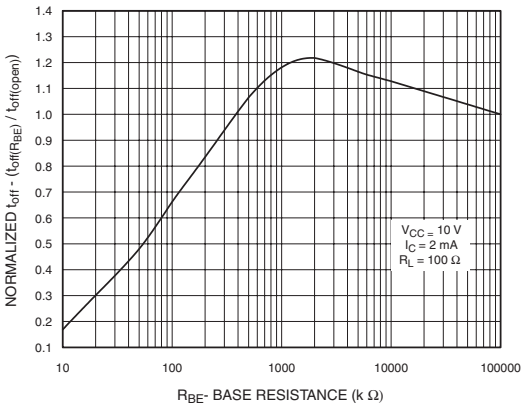
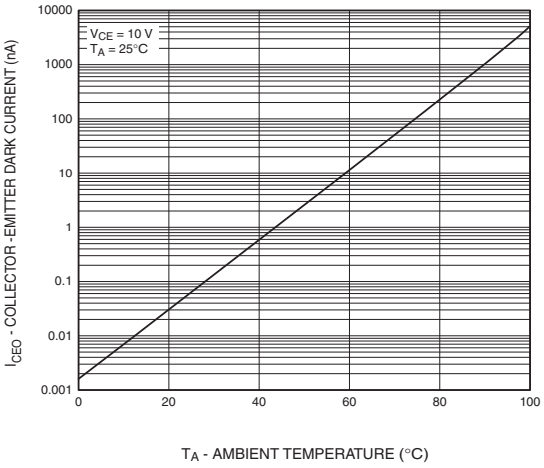


Fig. 18 Normalized t_{off} vs. R_{BE} (White Package)



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Fig. 19 Dark Current vs. Ambient Temperature



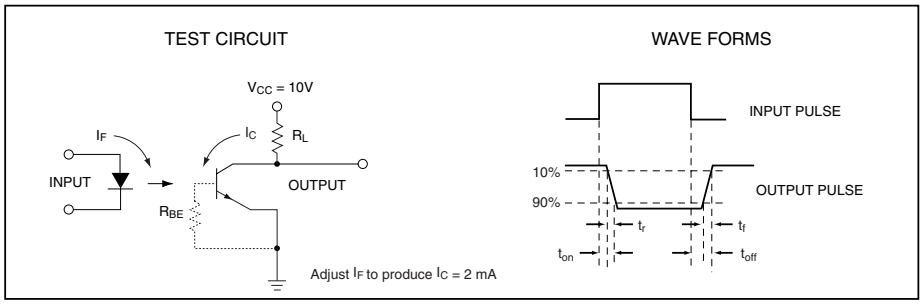


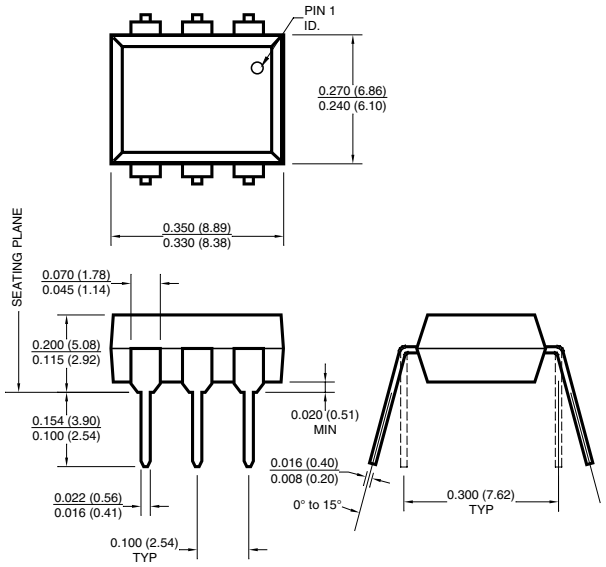
Figure 20. Switching Time Test Circuit and Waveforms

GENERAL PURPOSE 6-PIN PHOTOTRANSISTOR OPTOCOUPLERS

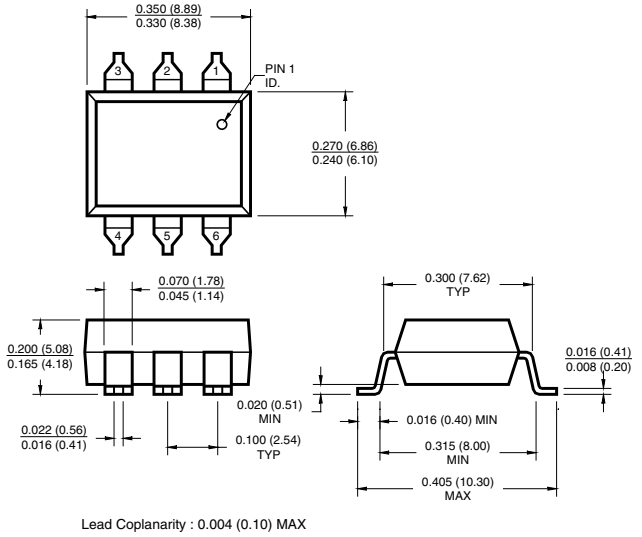
4N25	4N26	4N27	4N28	4N35	4N36
4N37	H11A1	H11A2	H11A3	H11A4	H11A5

Black Package (No -M Suffix)

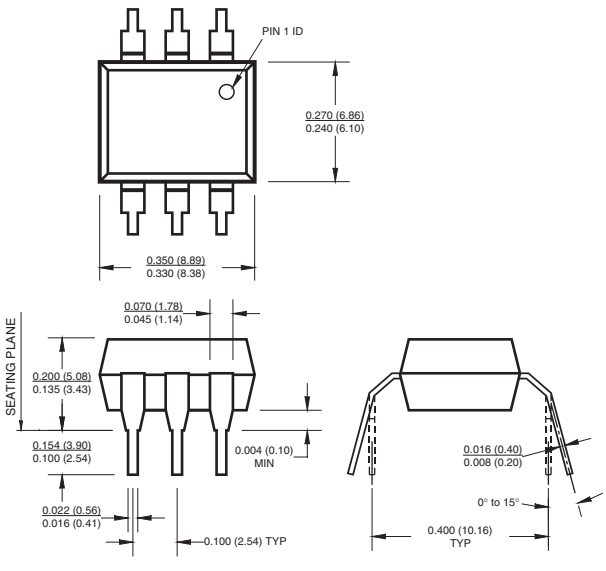
Package Dimensions (Through Hole)



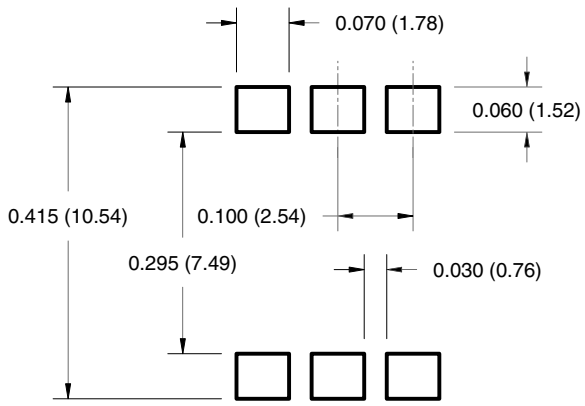
Package Dimensions (Surface Mount)



Package Dimensions (0.4" Lead Spacing)



Recommended Pad Layout for Surface Mount Leadform



NOTE
All dimensions are in inches (millimeters)

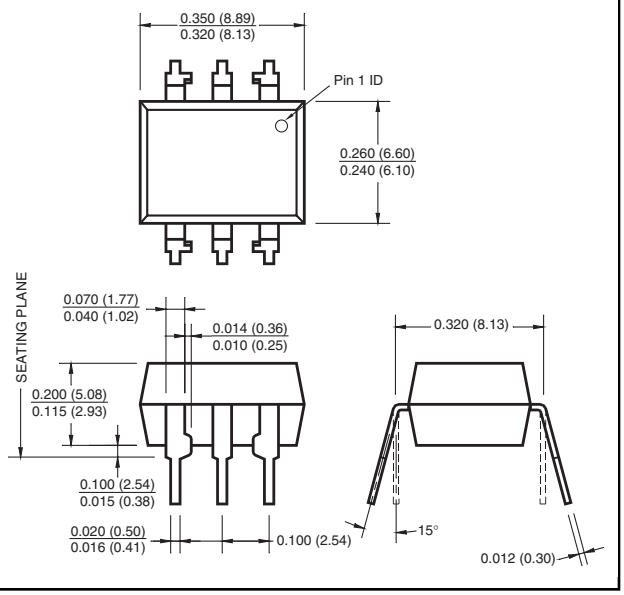
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GENERAL PURPOSE 6-PIN PHOTOTRANSISTOR OPTOCOUPLERS

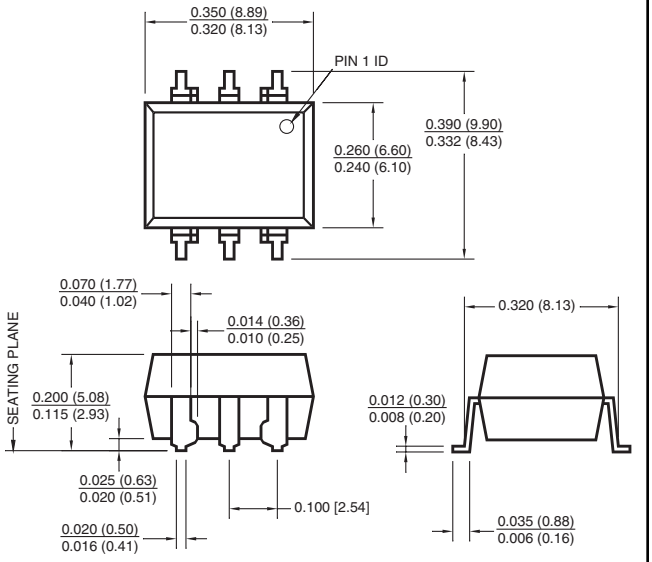
4N25	4N26	4N27	4N28	4N35	4N36
4N37	H11A1	H11A2	H11A3	H11A4	H11A5

White Package (-M Suffix)

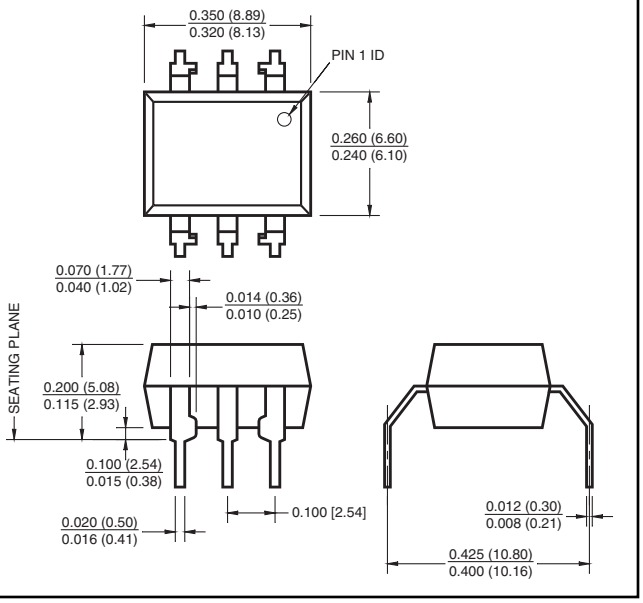
Package Dimensions (Through Hole)



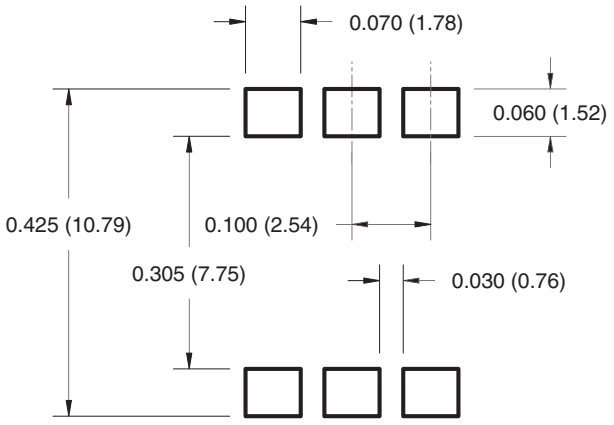
Package Dimensions (Surface Mount)



Package Dimensions (0.4" Lead Spacing)



Recommended Pad Layout for Surface Mount Leadform



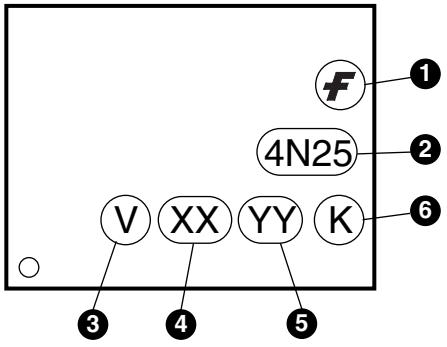
NOTE
All dimensions are in inches (millimeters)

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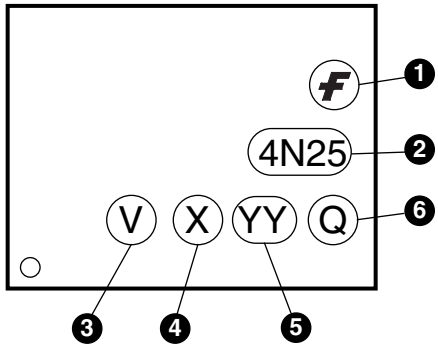
ORDERING INFORMATION

Order Entry Identifier		
Black Package (No Suffix)	**White Package (-M Suffix)**	**Option**
.S	S	Surface Mount Lead Bend
.SD	SR2	Surface Mount; Tape and reel
.W	T	0.4" Lead Spacing
.300	V	VDE 0884
.300W	TV	VDE 0884, 0.4" Lead Spacing
.3S	SV	VDE 0884, Surface Mount
.3SD	SR2V	VDE 0884, Surface Mount, Tape & Reel

MARKING INFORMATION



Black Package, No Suffix



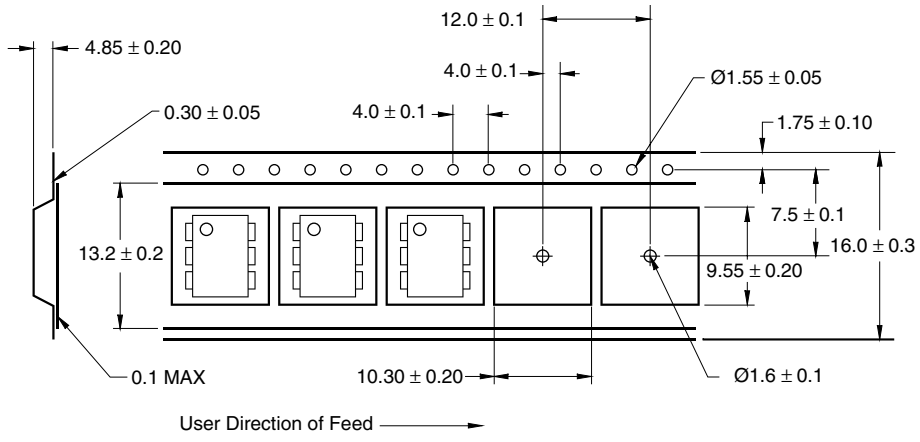
White Package, -M Suffix

Definitions	
1	Fairchild logo
2	Device number
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)
4	One or two digit year code • Two digits for black package parts, e.g., '03' • One digit for white package parts, e.g., '3'
5	Two digit work week ranging from '01' to '53'
6	Assembly package code

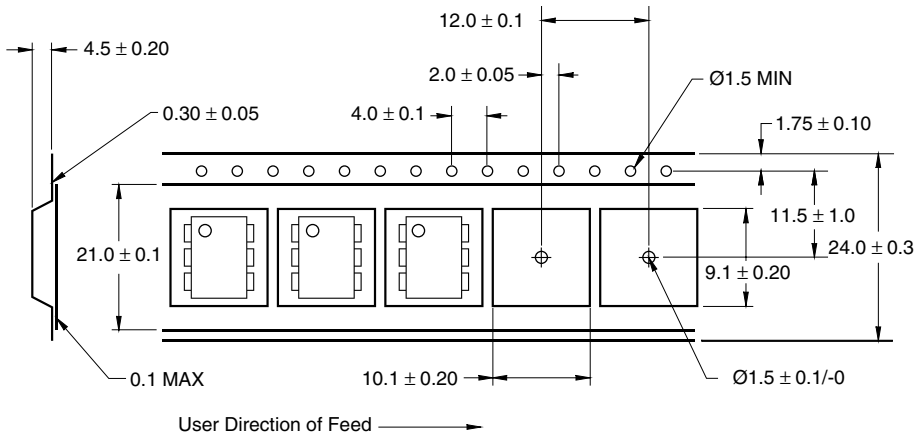
*Note – Parts built in the white package (M suffix) that do not have the 'V' option (see definition 3 above) that are marked with date code '325' or earlier are marked in the portrait format.

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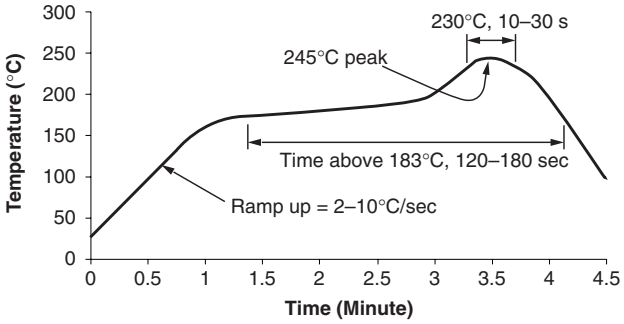
QT Carrier Tape Specifications (Black Package, No Suffix)



QT Carrier Tape Specifications (White Package, -M Suffix)

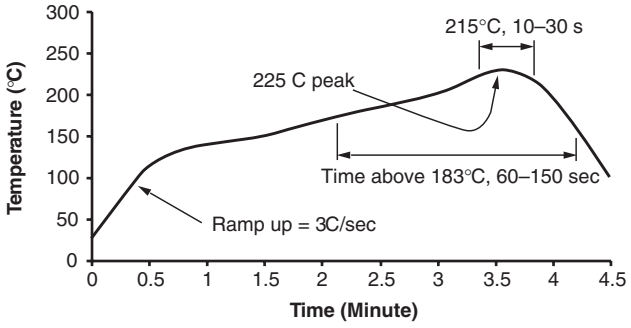


Reflow Profile (White Package, -M Suffix)



- Peak reflow temperature: 245°C (package surface temperature)
- Time of temperature higher than 183°C for 120–180 seconds
- One time soldering reflow is recommended

Reflow Profile (Black Package, No Suffix)



- Peak reflow temperature: 225°C (package surface temperature)
- Time of temperature higher than 183°C for 60–150 seconds
- One time soldering reflow is recommended

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GENERAL PURPOSE 6-PIN PHOTOTRANSISTOR OPTOCOUPLERS

4N25	**4N26**	**4N27**	**4N28**	**4N35**	**4N36**
4N37	**H11A1**	**H11A2**	**H11A3**	**H11A4**	**H11A5**

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Адрес: 105318, г.Москва, ул.Щербаковская д.3, офис 1107

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Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:
moschip.ru
moschip.ru_4
moschip.ru_6
moschip.ru_9